

SPECIFICATIONS

Mechanical

Mating Force: 40kgf max. Unmating Force: 4.4kgf min.

Durability: 30 Cycles

Electrical

Current Rating: 0.5A max.per contact

Contact Resistance: $55m\Omega$ max.(Initial), $75m\Omega$ max.(After) Dielectrical Withstanding Voltage: 200 VAC for 1 minute Insulation Resistance: 100 mega ohms min. at 500 VDC

Physical

Housing: LCP Black Color **Contact:** Copper Alloy

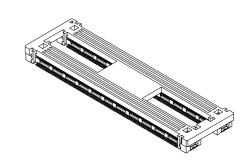
Plating: 6u" min. Gold Plating on Contact Area

Metal Ear: Copper Alloy

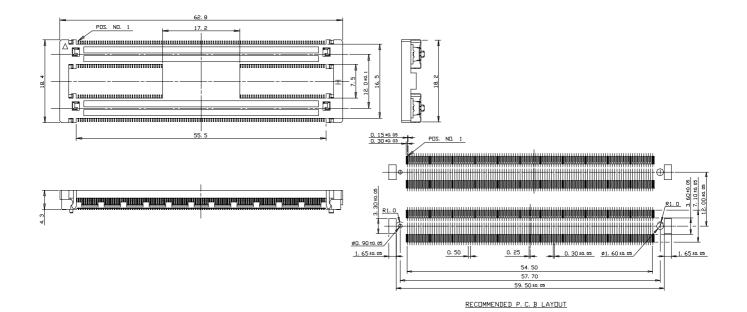
Operating Temperature: -40 $\mathcal C$ to +85 $\mathcal C$

Board to Board Connector

QT01 Series 0.5mm Pitch For High Speed Application Mated with QT00 Series



DRAWING



ORDERING INFORMATION

